

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
WOLFGANG SCHMID	01/20/2021
MAREN KUHLI	02/02/2021
CHRISTOPH SCHUH	01/22/2021
RECEIVING PARTY DATA	
Name:	DAIICHI SANKYO COMPANY, LIMITED
Street Address:	3-5-1, NIHONBASHI HONCHO, CHUO-KU
City:	TOKYO
State/Country:	JAPAN
Postal Code:	103-8426
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17255721
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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ATTORNEY DOCKET NUMBER:	1004413.070US9
NAME OF SUBMITTER:	NICHOLAS J. DICEGLIE, JR.
SIGNATURE:	/Nicholas J. DiCeglie, Jr./
DATE SIGNED:	02/26/2021
Total Attachments: 3	
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1. Name of conveying party: Wolfgang SCHMID Maren KUHLI Christoph SCHUH Additional name(s) of conveying party(ies) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No	2. Name and address of receiving party: Daiichi Sankyo Company, Limited 3-5-1, Nihonbashi Honcho, Chuo-ku Tokyo 103-8426, Japan Additional name(s) & addresses attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No
3. Nature of conveyance: <input type="checkbox"/> Change of Name <input checked="" type="checkbox"/> Assignment Execution Date: January 20, 2021, February 2, 2021, January 22, 2021, respectively.	4. Patent Application numbers: U.S. Serial No. 17/255,721, filed December 23, 2020; International Application No. PCT/JP2019/025363 filed on June 26, 2019; and Japanese Priority Application No. 2018-121423 filed on June 27, 2018.
5. Name and address of party to whom correspondence concerning document should be mailed: Name: Nicholas J. DiCeglie, Jr. Address: Locke Lord LLP Brookfield Place 200 Vesey Street, 20th Floor New York, New York 10281	6. Total number of applications involved: THREE 7. No fee Due(37 CFR 3.41): \$-0- <input type="checkbox"/> A check in the amount of _____ is enclosed. <input type="checkbox"/> Charge to Deposit Account No. , Order No.

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8. Statement and signature.
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of original document.

Name of Person Signing Nicholas J. DiCeglie, Jr.	Signature /Nicholas J. DiCeglie, Jr./	Date: February 26, 2021
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ASSIGNMENT OF APPLICATION FOR PATENT

WHEREAS:

- (1) Wolfgang SCHMID, c/o Daiichi Sankyo Europe GmbH
Luitpoldstrasse 1, Pfaffenhofen 85276, Germany**
- (2) Maren KUHLLI, c/o Daiichi Sankyo Europe GmbH
Luitpoldstrasse 1, Pfaffenhofen 85276, Germany**
- (3) Christoph SCHUH, c/o Daiichi Sankyo Europe GmbH
Luitpoldstrasse 1, Pfaffenhofen 85276, Germany**

(hereinafter referred to as ASSIGNOR(S)), has made a discovery or invention entitled:

GRANULES CONTAINING DIAMINE DERIVATIVE

- ☒ **for which application for Letters Patent Serial No. 17/255,721 was filed in the United States Patent and Trademark Office on December 23, 2020;**
- ☒ **for which International Application No. PCT/JP2019/025363, was filed on June 26, 2019; and**
- ☒ **for which Japanese Priority Application No. 2018-121423, was filed on June 27, 2018.**

WHEREAS:

**Daiichi Sankyo Company, Limited,
3-5-1, Nihonbashi Honcho, Chuo-ku
Tokyo 103-8426, Japan**

(hereinafter referred to as ASSIGNEE), is desirous of acquiring the entire interest in, to and under said invention and in, to and under Letters Patent or similar legal protection to be obtained therefor in the United States and in any and all foreign countries.

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN:

Be it known that for valuable consideration by ASSIGNEE to ASSIGNOR(S) , the receipt of which is hereby acknowledged, ASSIGNOR(S) hereby sells, assigns and transfers to ASSIGNEE, its successors, legal representatives and assigns, the full and exclusive right, title and interest to said discovery or invention in the United States and its territorial possessions and in all foreign countries and to all Letters Patent or similar legal protection in the United States and its territorial possessions and in any and all foreign countries to be obtained for said

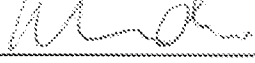
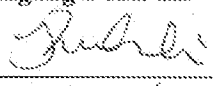
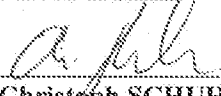
invention by said application or any continuation, division, renewal, substitute, reissue or reexamination thereof or any legal equivalent thereof in a foreign country for the full term or terms for which the same may be granted.

I, SAID ASSIGNOR(S), hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America and any Official of any country or countries foreign to the United States of America whose duty it is to issue Letters Patent on applications as aforesaid, to issue all such Letters Patent for said discovery or invention to the ASSIGNEE, as assignee of the entire right, title and interest in, to and under the same, for the sole use and behalf of the ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

I, SAID, ASSIGNOR(S), hereby covenant that I have full right to convey the entire right, title and interest herein sold, assigned, transferred and set over;

AND I, SAID ASSIGNOR(S) hereby further covenant and agree that the ASSIGNEE, its successors, legal representatives, or assigns, may apply for foreign Letters Patent on said discovery or invention and claim the benefits of the International Convention, and that I will, at any time, when called upon to do so by the ASSIGNEE, its successors, legal representatives, or assigns, communicate to the ASSIGNEE, its successors, legal representatives, or assigns, as the case may be, any facts known to me respecting said discovery or invention, and execute and deliver any and all lawful papers that may be necessary or desirable to perfect the title to the said discovery or invention, the said applications and the said Letters Patent in the ASSIGNEE, its successors, legal representatives and assigns, and that if reissues or reexaminations of the said Letters Patent or disclaimers relating thereto, or divisions, continuations, or refilings of the said applications, or any thereof, shall hereafter be desired by the ASSIGNEE, its successors, legal representatives, or assigns, I will, at any time, when called upon to do so by the ASSIGNEE its successors, legal representatives, or assigns, sign all lawful papers, make all rightful oaths, execute and deliver all such disclaimers and all divisional, continuation, reissue and reexamination applications so desired, and do all lawful acts requisite for the application for such reissues and the procuring thereof and for the filing of such disclaimers and such applications, and generally do everything possible to aid the ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention or discovery in all countries, all without further compensation but at the expense of the ASSIGNEE, its successors, legal representatives and assigns.

Signed:

(1)	 _____ Wolfgang SCHMID	Date	<u>20.01.2021</u> _____
(2)	 _____ Maren KUHLE	Date	<u>02.02.2021</u> _____
(3)	 _____ Christoph SCHUH	Date	<u>22.01.2021</u> _____